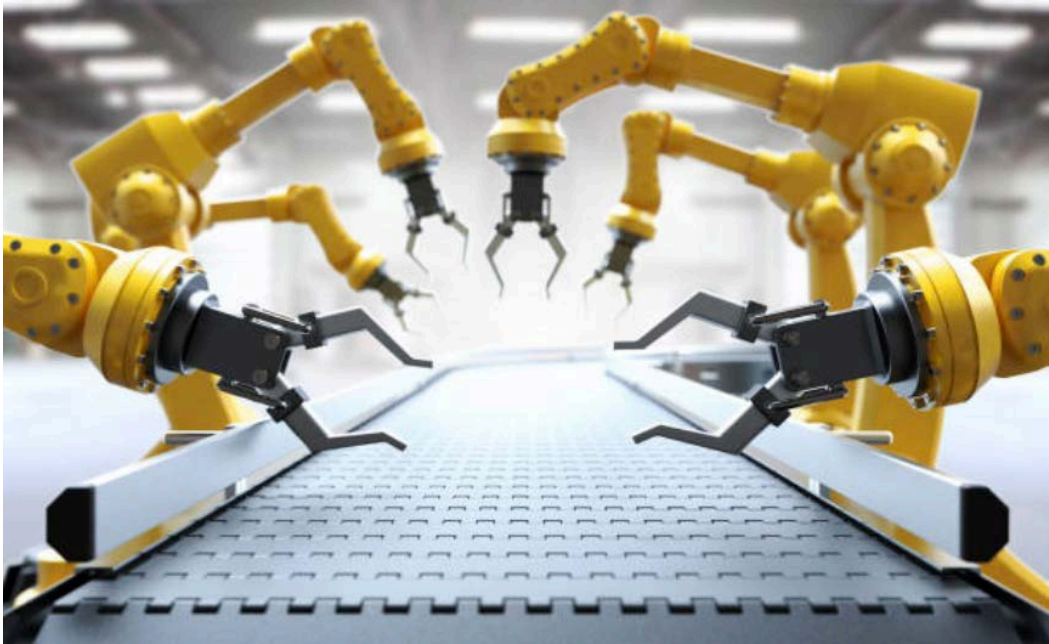




BLDC Position Control

Motor Driver IC and a 32-bit MCU in a 7 x 7 mm Footprint



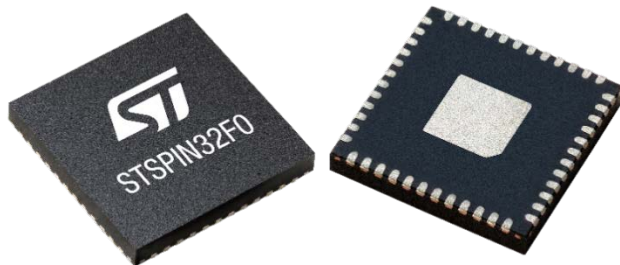
STSPIN32F0 Key Features and Benefits

Position Control Demo

MCU for Motor Control

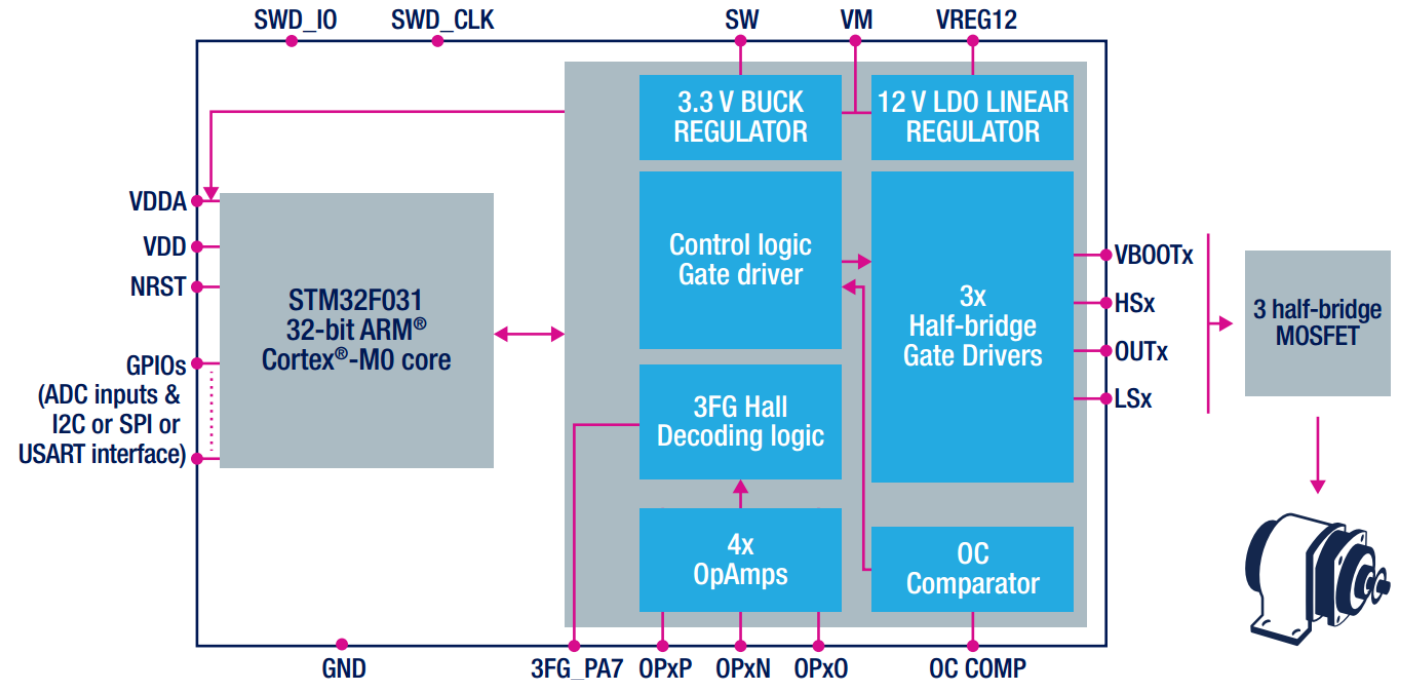
ANALOG and POWER for Motor Control

Design Support Tools



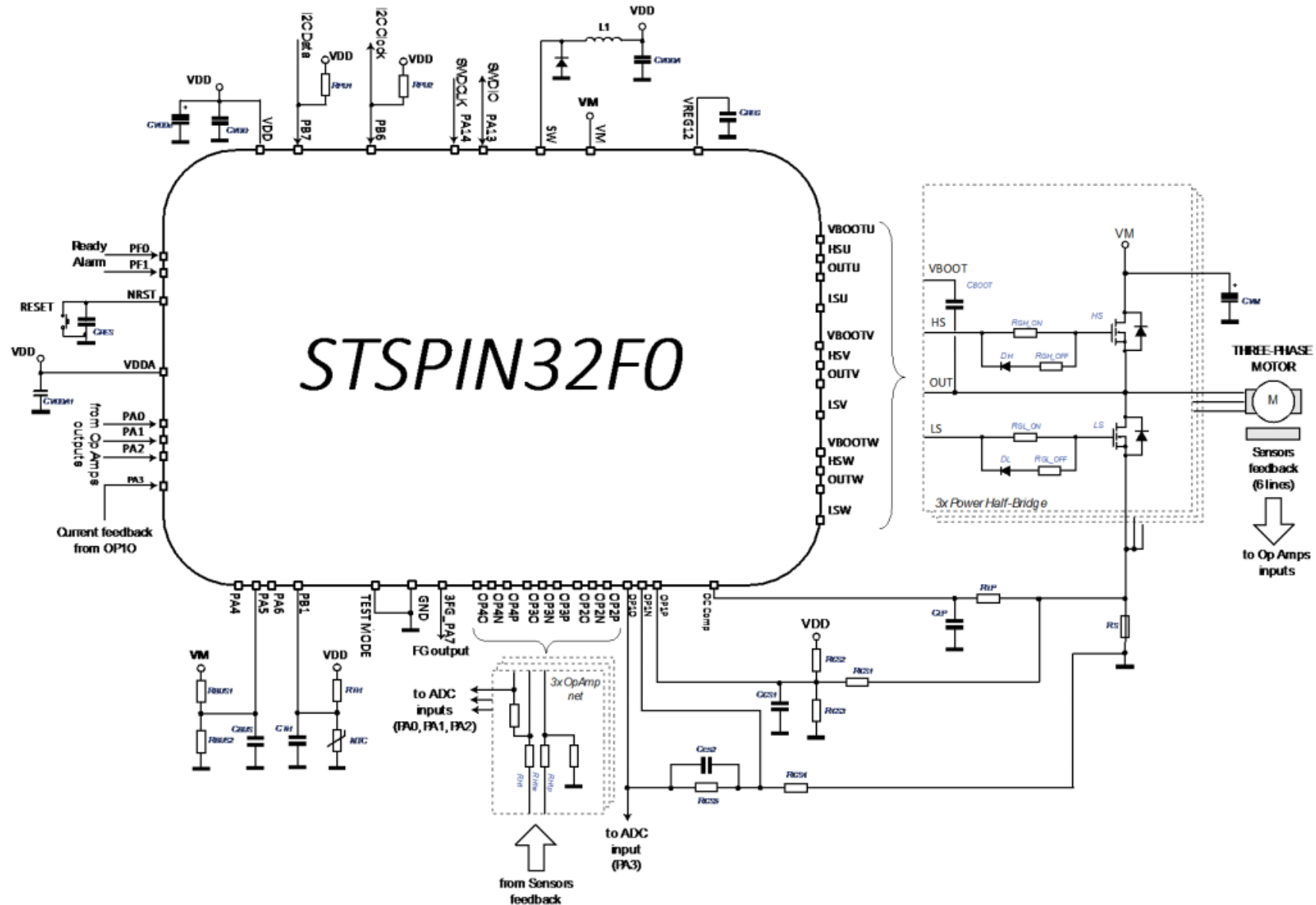
STSPIN32F0 Technical Details

- **Operating voltage from 8V to 45V**
- **3-phase gate driver for high performances**
 - 600mA current capability
 - Real-time programmable over current
 - Integrated bootstrap diodes
 - Cross conduction, under-voltage and temperature protections
- **32-bit STM32F0 MCU with ARM® Cortex® M0 Core**
 - STM32F031x6x7 48MHz, 4-Kbyte SRAM and 32-Kbyte Flash memories
 - 12-bit ADC
 - 1 to 3 shunts FOC supported
 - Communication interfaces I2C, UART and SPI
 - Complete Development Ecosystem available
- **4x Operational Amplifiers and a Comparator**
 - Sensor-less or Hall-effect sensors supported for accurate control of 3-phase motors
 - Wide Bandwidth 20MHz
 - Adjustable Comparator's threshold
- **On-chip generated supplies for MCU driver and external circuitry**
 - 3.3V DC/DC buck regulator – Input voltage up to 45V
 - 12V LDO linear regulator
 - UVLO protection on all power supply voltages
- **Embedded Over-Temperature Protection**



- **Package : VFQFPN 7 x 7 x 1.0 - 48L**

STSPIN32F0 Application Example



Hardware Platform

STEVAL-SPIN3201



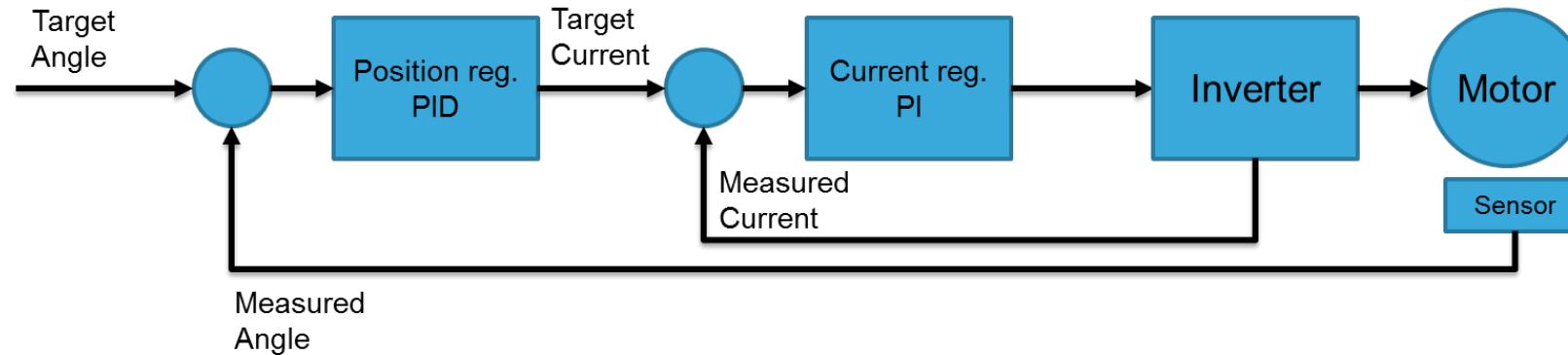
- Input voltage from 8 V to 45 V
- Output current up to 15 Arms
- Power stage based on STD140N6F7 MOSFETs
- 3-shunt current sensing
- Digital Hall sensors and encoder input
- Overcurrent comparator
- Bus voltage sensing
- Fully supporting STM32 PMSM FOC Software Development Kit
- Embedded ST-LINK/V2-1

STSPIN32F0



- Three-phase gate drivers
 - 600 mA sink/source
 - Integrated bootstrap diodes
 - Cross-conduction prevention
- 32-bit ARM® Cortex®-M0 core:
 - Up to 48 MHz clock frequency
 - 4-kByte SRAM
 - 32-kByte Flash memory
- 16 GPIO
- 5 general-purpose timers
- 12-bit ADC converter (up to 9 channels)
- I2C, USART and SPI interfaces
- 4 rail-to-rail operation amplifiers
- Extended temperature range: -40 to +125 °C

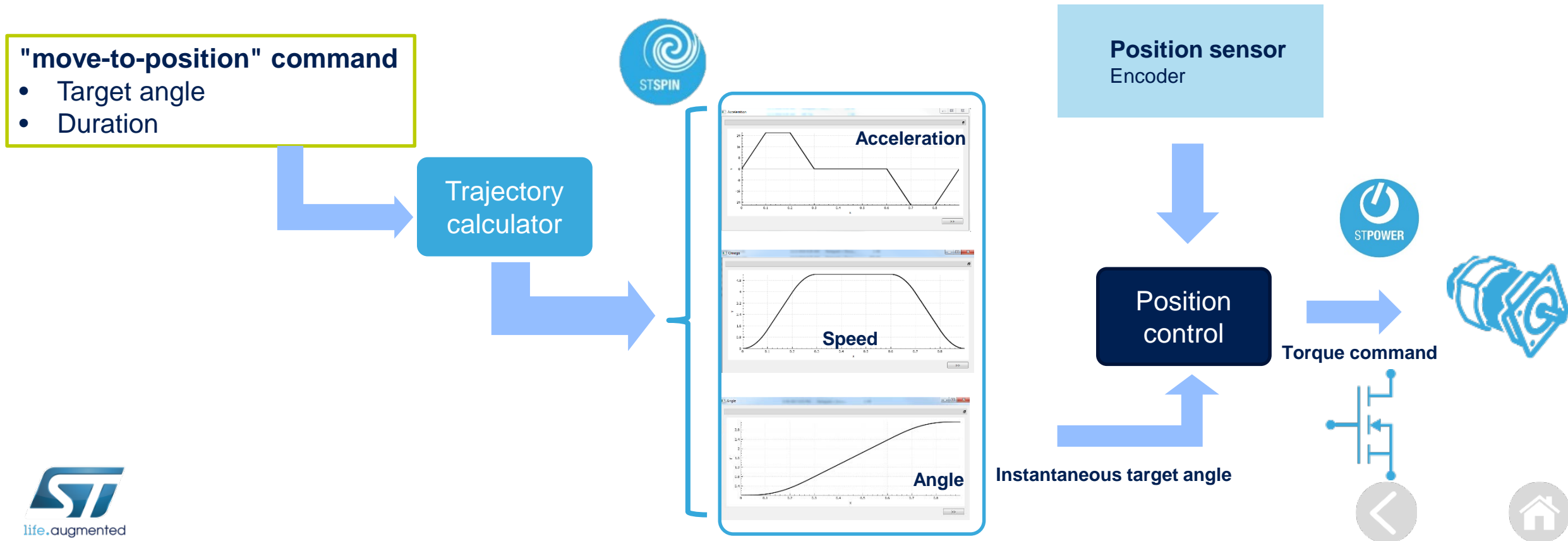
The Demo



- Two small motors are precisely synchronized allowing the intersection of two disks, performing accurate **position control** and thus avoiding collision, playing at different speeds and accelerations.
- With **STSPIN32F0** as main core, the demo show the capabilities of a **servo drive**.

Full Featured Position Control

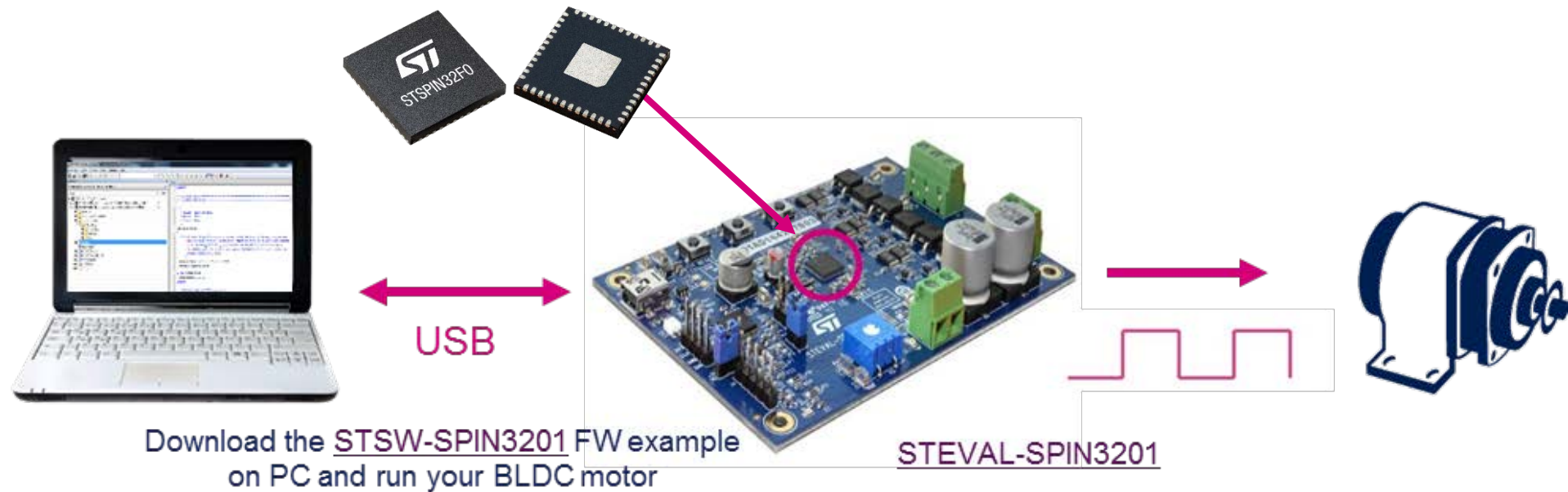
- A dedicated **trajectory** (as a sequence of target positions) is calculated starting from a
- "move-to-position" command.
- The trajectory is computed applying a constant angular **Jerk** approach.
- The Jerk is the rate of change of acceleration; that is, the time derivative of acceleration.





Design Support Tools

A complete environment for the development of an FOC solution





Making Your Designs Easier

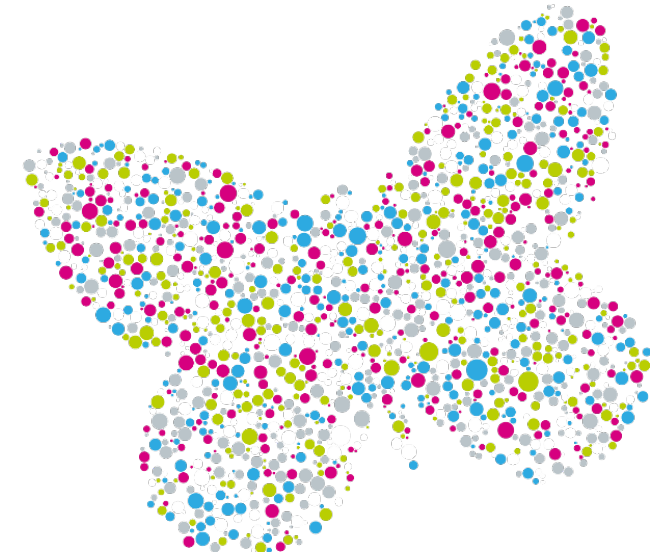
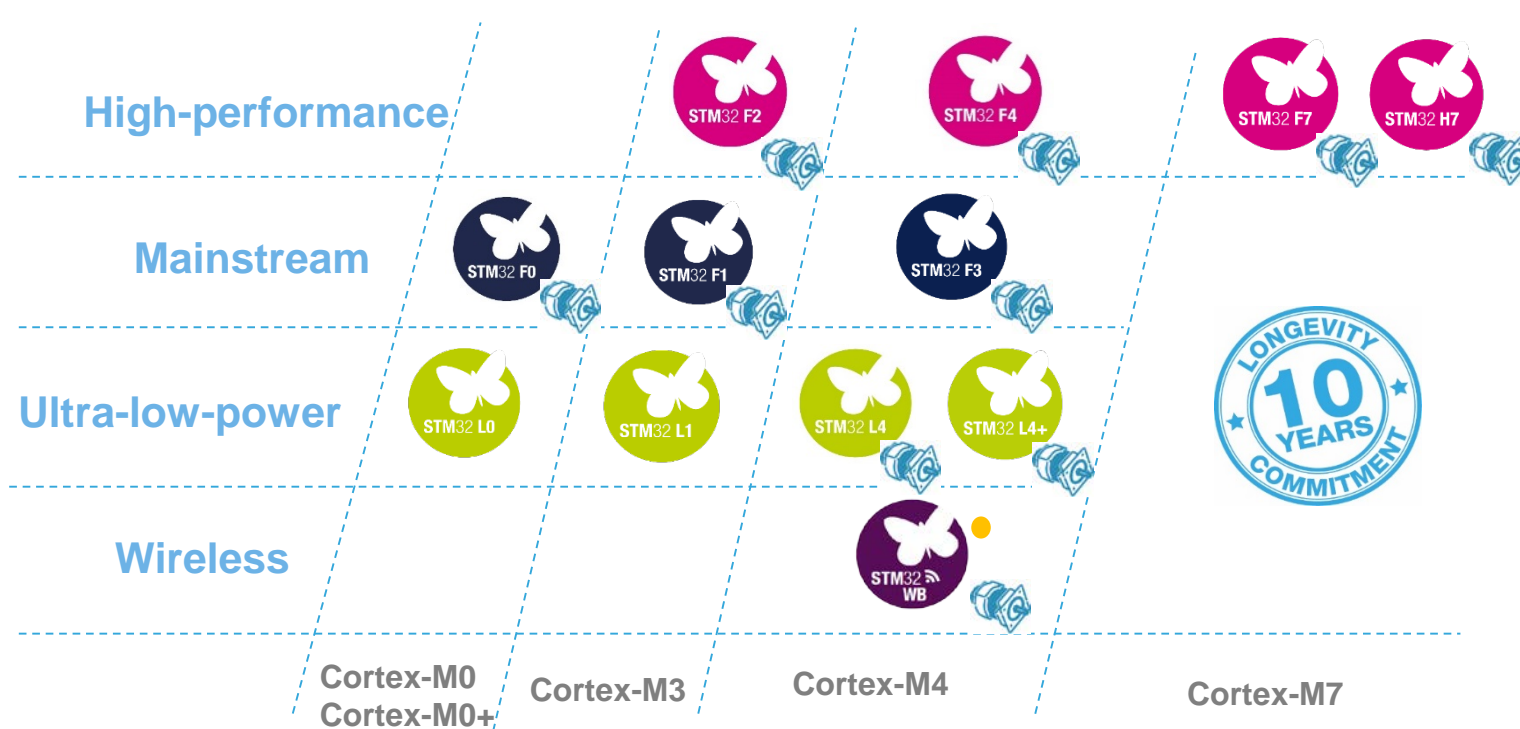
To support STSPIN32F0, a comprehensive set of design tools is available, including:

Reference Code	Description
STEVAL-SPIN3201	<p>STSPIN32F0 evaluation board</p> <p>Three-phase brushless DC motor driver evaluation board</p> <ul style="list-style-type: none">• Input voltage from 8 to 45 V• Output current up to 15 Arms• Power stage based on STD140N6F7 MOSFETs• Sensored or sensorless field-oriented control algorithm with 3-shunt sensing
UM2154	User manual for STEVAL-SPIN3201: advanced BLDC controller with embedded STM32 MCU evaluation board
STSW-SPIN3201	Firmware example for field oriented motor control (FOC)
UM2152	User manual for Getting started with the STSPIN32F0 FOC firmware example STSW-SPIN3201
STSW-STM32100	Library: STM32 PMSM FOC Software Development Kit



STM32 Portfolio

12 Product Series / More than 50 Product Lines



More than
40,000 customers

Legend: Cortex-M0+ Radio Co-processor

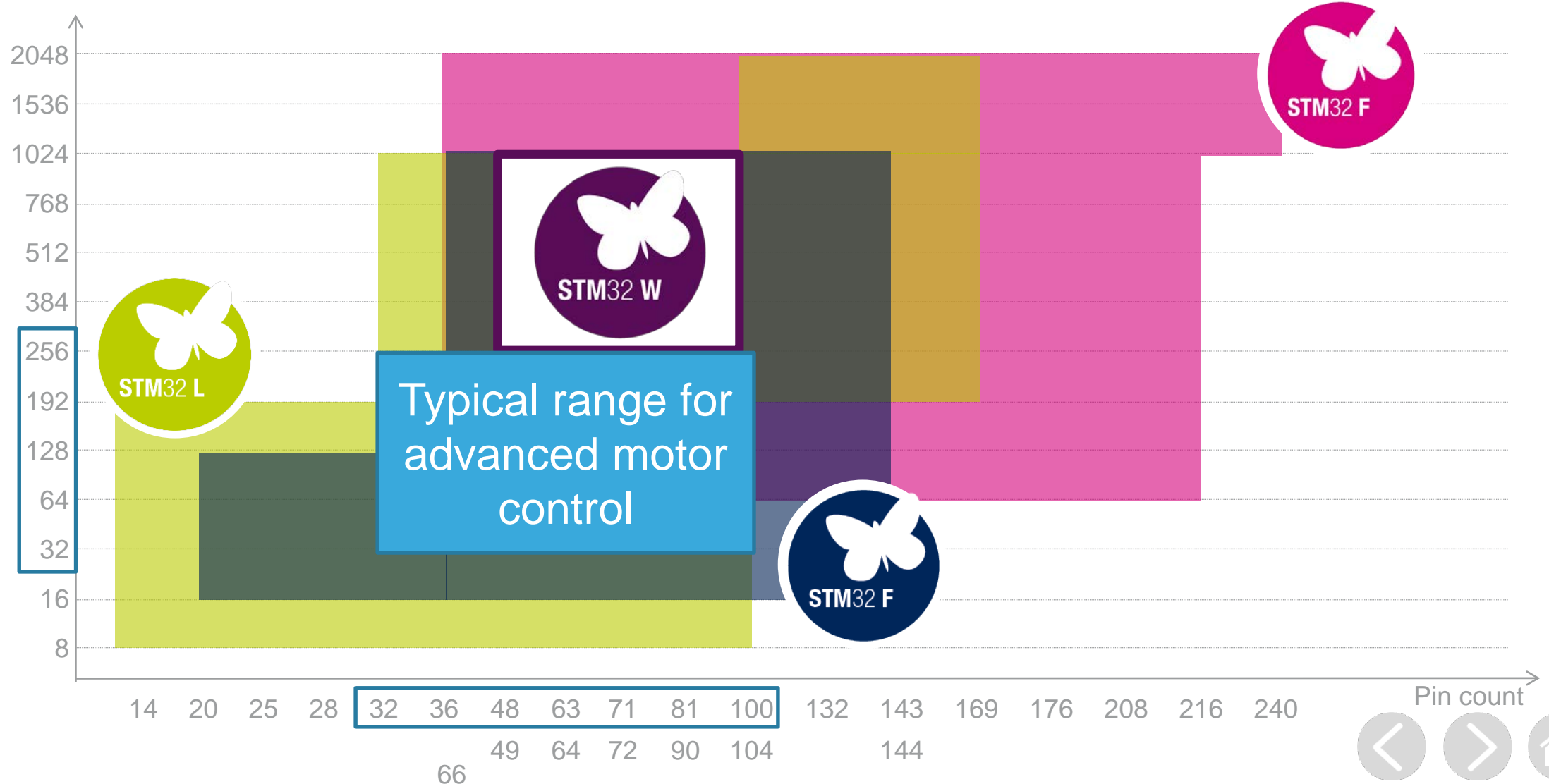


Advanced motor control timer included

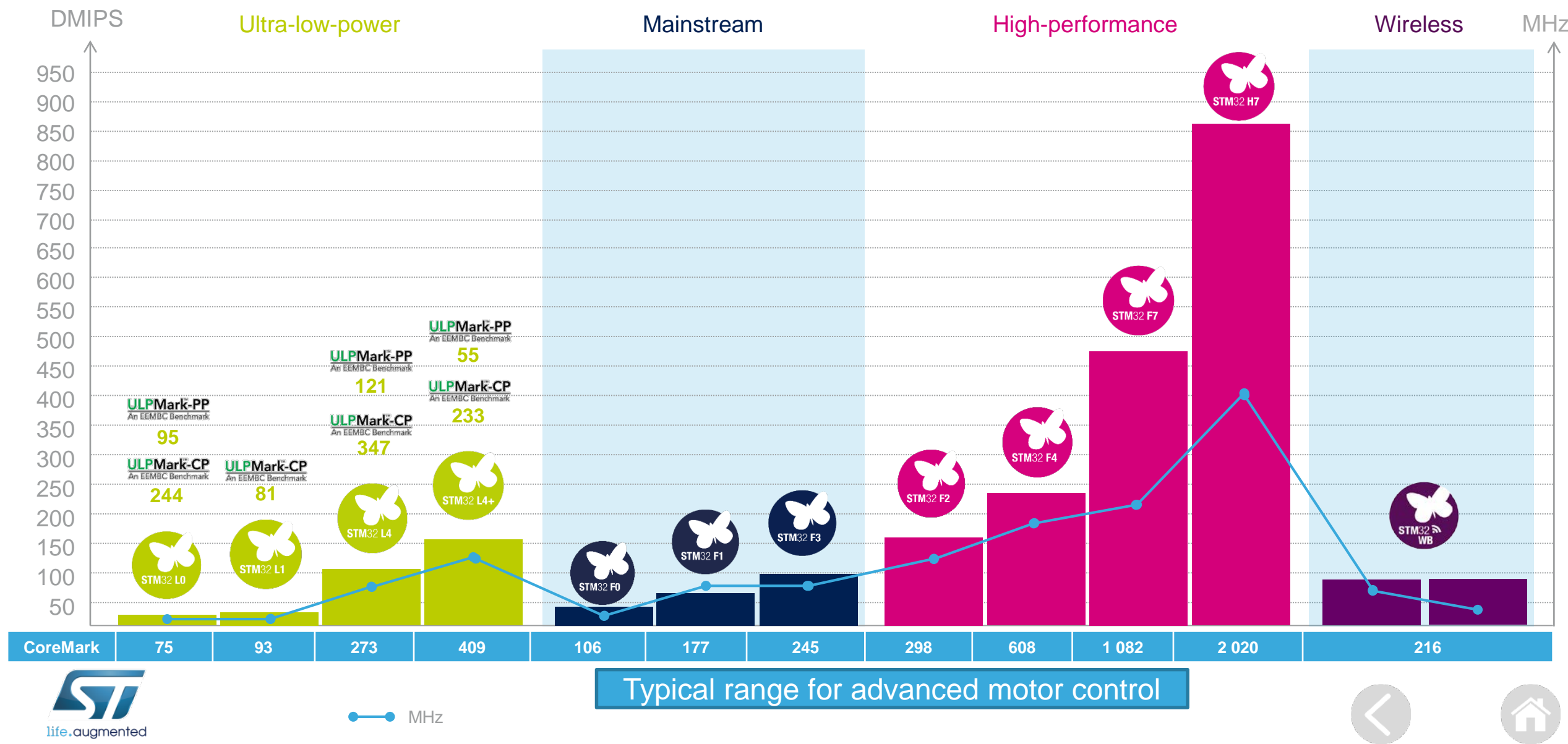
STM32 today – platform effect

Select the Best Fitting Product from a Wide & Compatible Portfolio

Flash memory size (Kbytes)



Broadest 32-bit MCU product portfolio





STDRIVE – Product Family and Positioning

IGBT and MOSFET Drivers

Applications

Auto
HEV/EV

1200V
inverters

Industrial
Drives

Washing
machines

Compressors

Dish washers

HID

E-bikes

Server

UPS

DC/DC Auto

Solar

Factory
automation

Low & High Voltage Gate Drivers

L638xE SERIES

600V HB drivers for IGBT/MOS

L639x SERIES

600V HB drivers for IGBT/MOS
optimized for FOC

L649x SERIES

600V high current HB drivers for
IGBT/MOS

TD3xxE

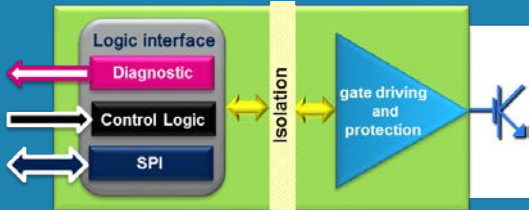
Single channel drivers with functional
isolation & 2-level turn-off

600V

Galvanically isolated Gate Drivers

• STGAP1AS

1.5kV



50W

200W

1kW

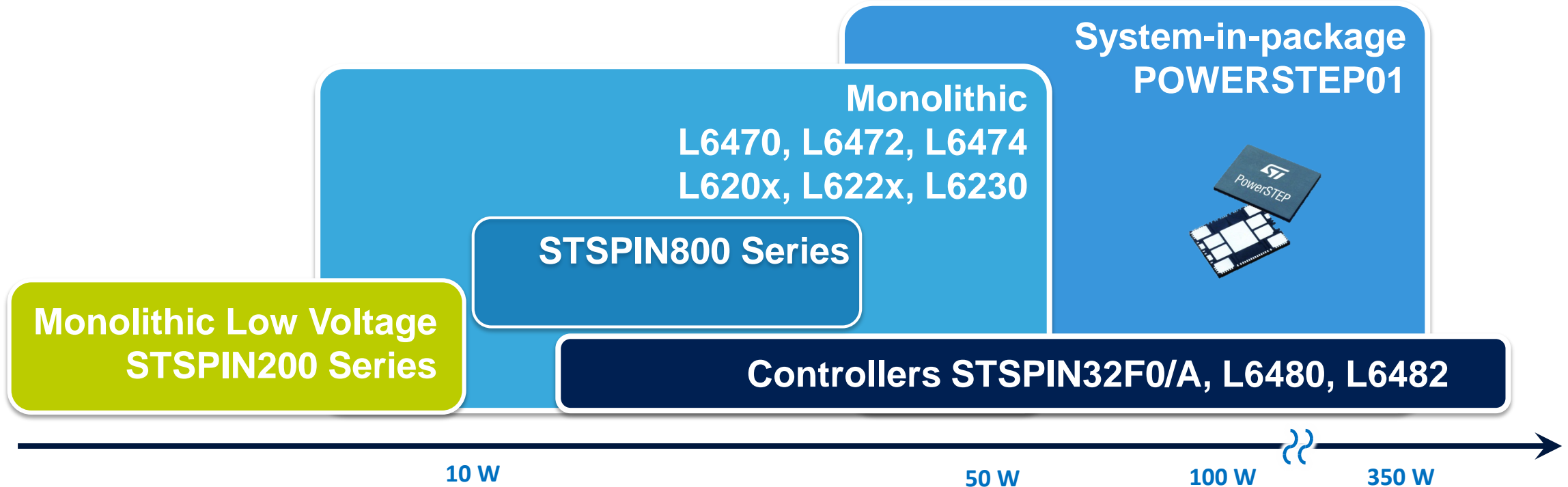
100kW

Power



STSPIN Family Portrait

Leading Integration, Performance, Efficiency



Portable, Battery Powered

Medical, Security, ATM, Vending,
3D Printers, Domotics







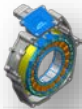
Stage Lighting

Industrial, Factory Automation





STSPIN Family Positioning

	Monolithic motor drivers 	LV motor drivers 	Microstepping motor drivers 	High Power microstepping 
STEPPER 	Dual full-bridges L6208 L6228 L6208Q L6228Q STSPIN820	Dual full-bridge STSPIN220	Dual full-bridges L6470 (VM) L6474 L6472 (PCAD)	Controllers & SiP L6480 (VM) L6482 (PCAD) POWERSTEP01
BRUSHED DC 	Dual full-bridges L6205 L6225 L6206/Q L6226/Q L6207/Q L6227/Q STSPIN840	Dual full-bridge STSPIN240 STSPIN250		
3-PHASE BLDC 	Triple half-bridges L6235/Q L6229/Q L6234 L6230/Q STSPIN830	Triple half-bridge STSPIN230 STSPIN233		

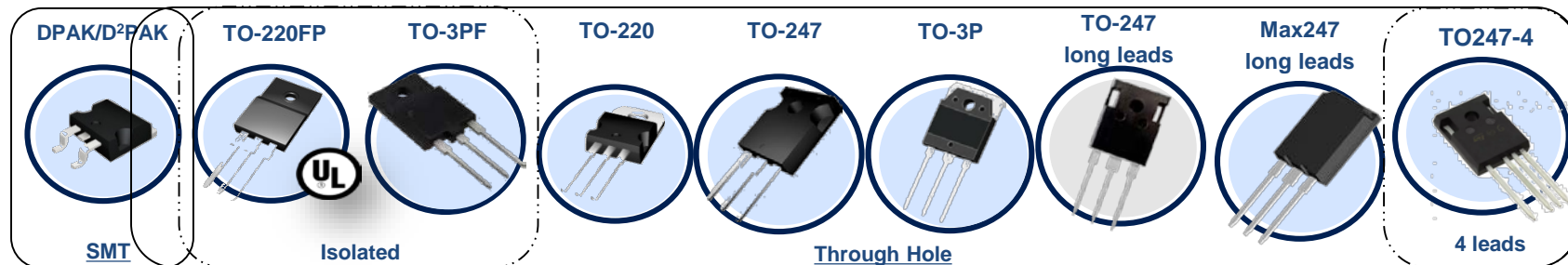
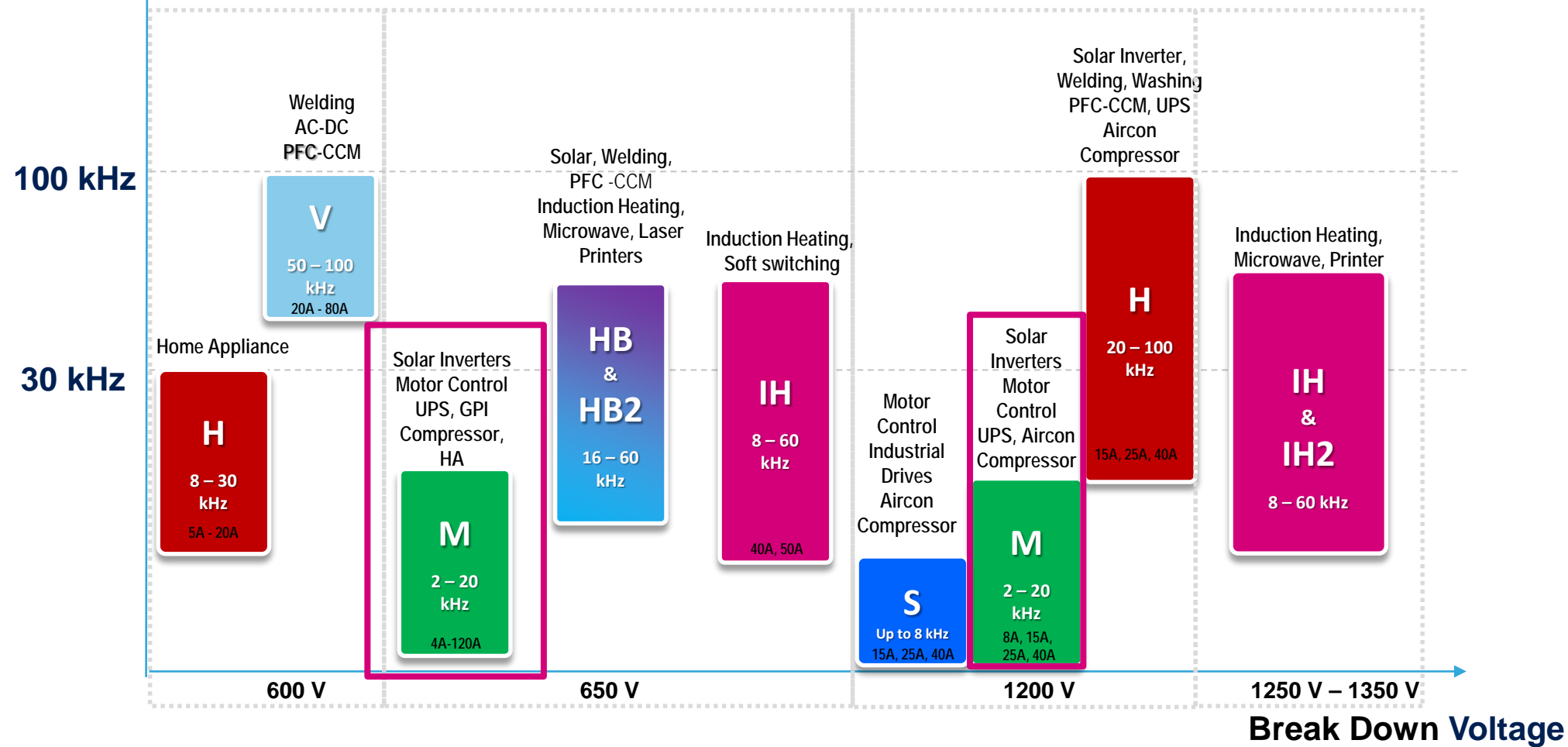
VM = Voltage mode

PCAD = Predictive Current control with Adaptive Decay

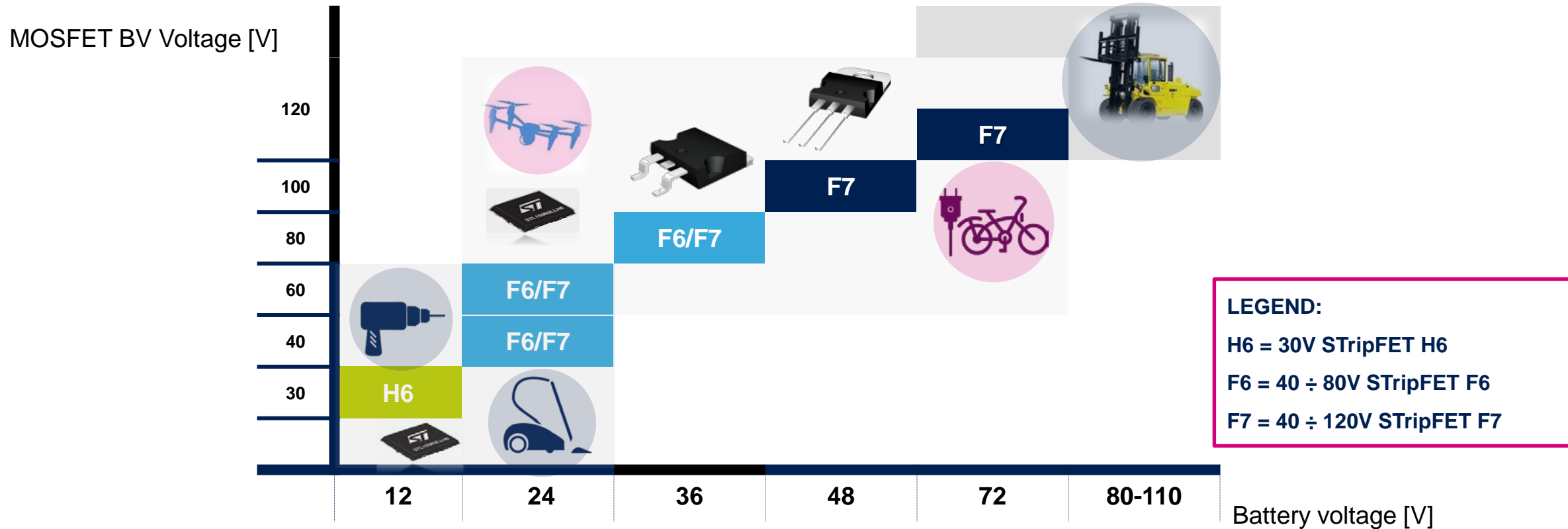
DME = Digital Motion Engine generates motion profiles thru commands sent over SPI

IGBTs positioning (from 600V to 1350V)

Switching frequency



Low Voltage STripFET™ Positioning vs Battery Voltage



Technology Features

- Best in class On-resistance
- High current capability
- High quality & reliability
- Wide packaging options

Benefits

- Higher efficiency and system miniaturization
- Lower battery consumption
- Reliable system operation

Discrete vs Integrated Approach



Advantages of integrated Power Modules (IPM)

High power dissipation due to a very low thermal resistance

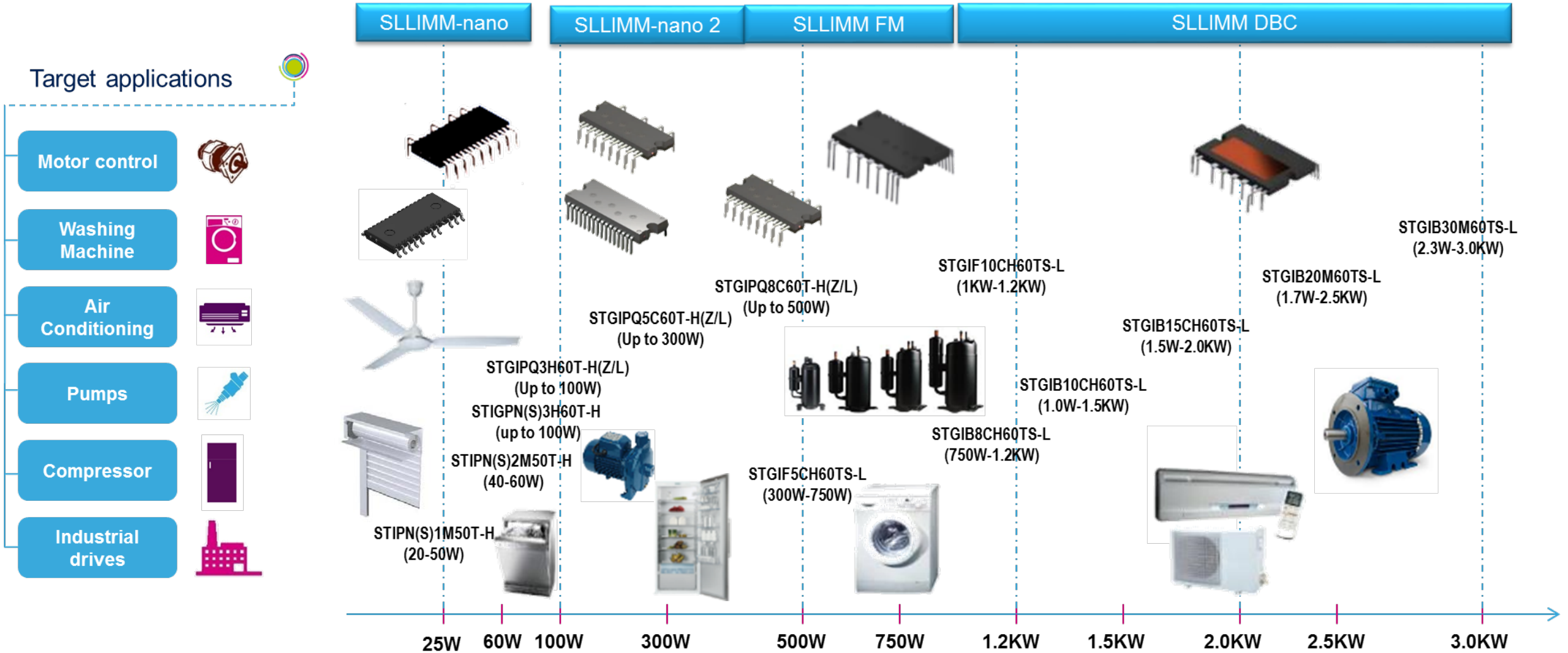
Lower losses and EMI noise thanks to simultaneous optimization of power chips and driving circuits

«Plug 'n Play» solution

Improved manufacturability and PCB routing, only one component to handle

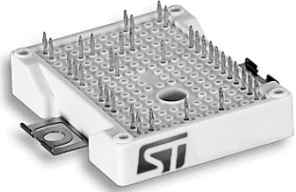
Reduced design time and improved reliability thanks to embedded protection

SLLIMM™ Intelligent Power Modules



Main Features and ST capability in “Power Switch”

ACEPACK™ 2

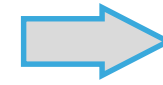


ACEPACK™ 1



Main Features

- Compact module concept
- Configuration flexibility
- Press FIT and solder pins options
- High power density
- Reliable and easy mounting system
- Integrated temperature sensor available
- Low stray inductance module design
- PCB layout design
- High reliability and quality
- RoHS-compliant modules



ST Power Switch capability

- IGBTs
- HV MOSFETs
- Diodes
- Bridge Rectifier Diodes
- Silicon Carbide MOSFETs
- Silicon Carbide Diodes
- SCR

Main Topologies can be addressed in ACEPACK

